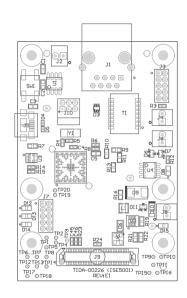
ZZ4m Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

ZZI These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZZ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: [No Variations]

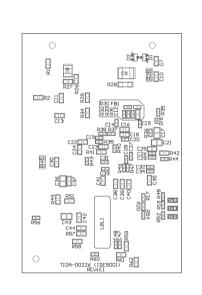
PCB VIEWED FROM TOP SIDE BOARD #: TIDA-00203 REV:E1 SUN REV: Not In VersionControl

LAYER NAME = ASSEMBLY TOP

CAN-to-Ethernet Converter

PLOT NAME = Top Assembly Drawing

GENERATED : 12/16/2014 12:12:41 PM TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE BOARD #: TIDA-00203

REV: E1

SUN REU: Not In VersionControl

LAYER NAME = ASSEMBLY BOTTOM

PLOT NAME=Bottom Assembly Drawing

CAN-to-Ethernet Converter GENERATED:

12/16/2014 12:12:45 PM TEXAS INSTRUMENTS

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